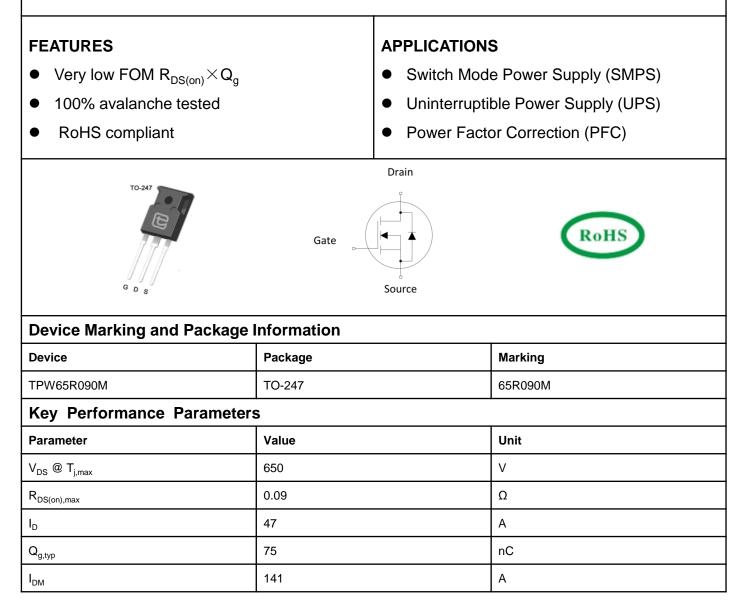


650V Super-Junction Power MOSFET

DESCRIPTION

650V super-junction Power MOSFET

Super-junction power MOSFET is a revolutionary technology for high voltage power MOSFETs, designed according to the SJ principle. The SJ MOSFET is a price-performance optimized product enabling to target cost sensitive applications in Consumer and Lighting markets, designed by Wuxi Unigroup Microelectronics Company.





Absolute Maximum Ratings $T_c = 25^{\circ}C$, unless otherwise noted					
Parameter		Symbol	Value	Unit	
Drain-Source Voltage (V _{GS} = 0V)		V _{DSS}	650	V	
Continuous Drain Current	$T_{\rm C} = 25^{\circ}{\rm C}$	l _D	47	A	
	TC = 100°C		28.2		
Pulsed Drain Current (note1)		I _{DM}	141	A	
Gate-Source Voltage		V _{GSS}	±30	V	
Single Pulse Avalanche Energy (note2)		E _{AS}	1160	mJ	
Repetitive Avalanche Energy (note2)		E _{AR}	1.76	mJ	
Avalanche Current		I _{AR}	9.3	A	
MOSFET dv/dt ruggedness, V _{DS} = 0480V		dv/dt	50	V/ns	
Power Dissipation		P _D	391	W	
Continuous Body Diode Current		۱ _s	40		
Pulsed Diode Forward Current	(note1)	I _{SM}	141	A	
Reverse diode dv/dt (note3)		dv/dt	15	V/ns	
Maximum diode commutation speed (note3)		di _f /dt	300	A/us	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55~+150	°C	

Thermal Resistance					
Parameter	Symbol	Value	Unit		
Thermal Resistance, Junction-to-Case	R _{thJC}	0.32	•C/W		
Thermal Resistance, Junction-to-Ambient	R _{thJA}	62	°C/W		



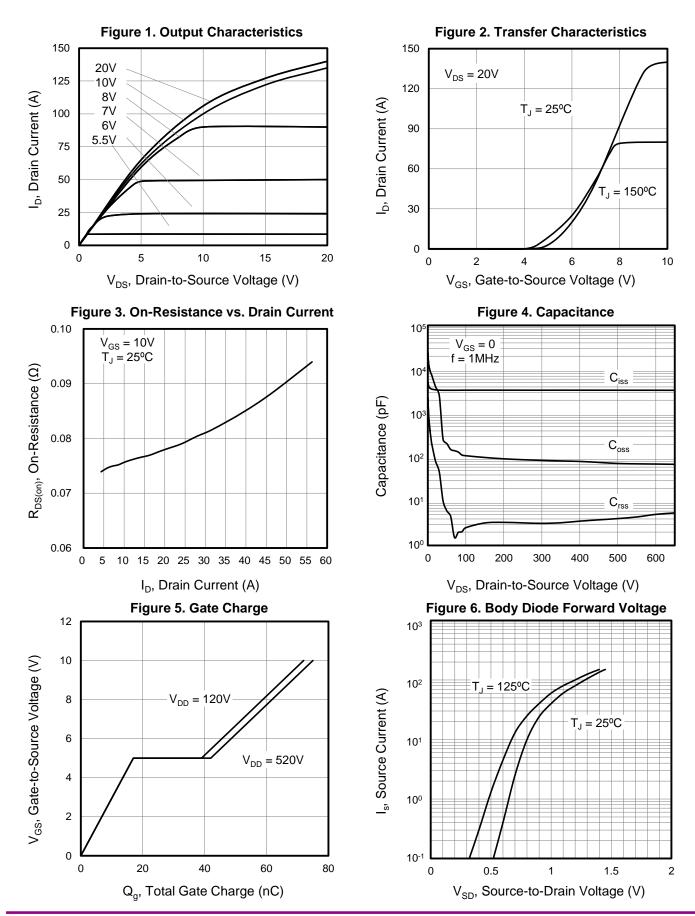
Devenueter			Value				
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0V, I_{D} = 250\mu A$	650			V	
Zero Gate Voltage Drain Current		$V_{DS} = 650V, V_{GS} = 0V, T_{J} = 25^{\circ}C$			1	μA	
	I _{DSS}	$V_{DS} = 650V, V_{GS} = 0V, T_{J} = 150^{\circ}C$			100		
Gate-Source Leakage	I _{GSS}	$V_{GS} = \pm 30 V$			±100	nA	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	2.5		4.5	V	
Drain-Source On-Resistance	R _{DS(on)}	V _{GS} = 10V, I _D = 24A		0.079	0.09	Ω	
Gate resistance	R _G	f = 1.0MHz open drain		0.8		Ω	
Dynamic							
Input Capacitance	C _{iss}			3370		pF	
Output Capacitance	C _{oss}	$V_{GS} = 0V,$ $V_{DS} = 100V,$		109			
Reverse Transfer Capacitance	C _{rss}	f = 1.0MHz		2.5			
Total Gate Charge	Qg			75		nC	
Gate-Source Charge	Q _{gs}	$V_{DD} = 520V, I_{D} = 47A, V_{GS} = 10V$		17			
Gate-Drain Charge	Q _{gd}			25			
Turn-on Delay Time	t _{d(on)}			46			
Turn-on Rise Time	t _r	V _{DD} = 400V, I _D = 47A,		79			
Turn-off Delay Time	t _{d(off)}	$R_{\rm G} = 25\Omega$		185		ns	
Turn-off Fall Time	t _f			64			
Drain-Source Body Diode Characte	eristics						
Body Diode Voltage	V _{SD}	T _J = 25°C, I _{SD} = 24A, V _{GS} = 0V		0.9	1.2	V	
Reverse Recovery Time	t _{rr}			400		ns	
Reverse Recovery Charge	Q _{rr}	V _R = 400V, I _F = 20A, di _F /dt = 100A/µs		8		μC	
Peak Reverse Recovery Current	I _{rrm}			39.8		А	

Notes

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature
- 2. I_{AS} = 9.3A, V_{DD} = 50V, R_{G} = 25 Ω , Starting T_{J} = 25°C
- 3. Identical low side and high side switch with identical ${\sf R}_{\sf G}$



Typical Characteristics $T_J = 25^{\circ}C$, unless otherwise noted



 $I_{D} = 250 \mu A$

90

10²

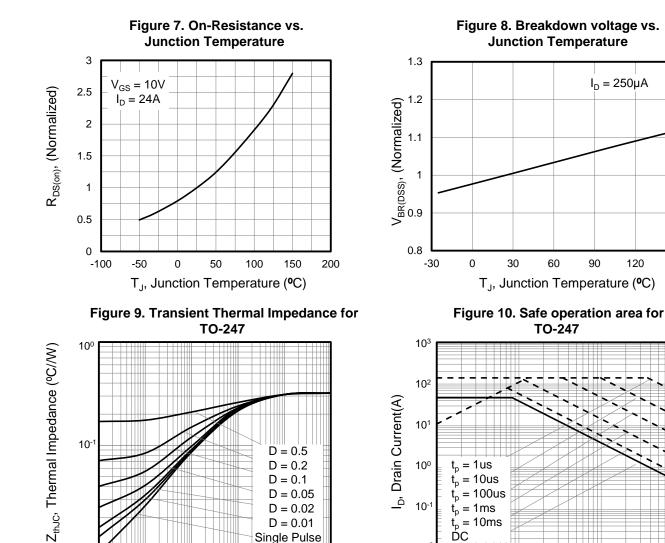
V_{DS}, Drain-Source Voltage(V)

120

150

10³

Wuxi Unigroup Microelectronics Co.,Ltd



Single Pulse

10⁰

10-1

Typical Characteristics $T_J = 25^{\circ}C$, unless otherwise noted

V_{DS}, Drain-Source Voltage(V)

10

10-5

10-4

10⁻³

T_p, Pulse Width (s)

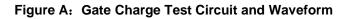
10⁻²

ĎС

10¹

10-2

10⁰



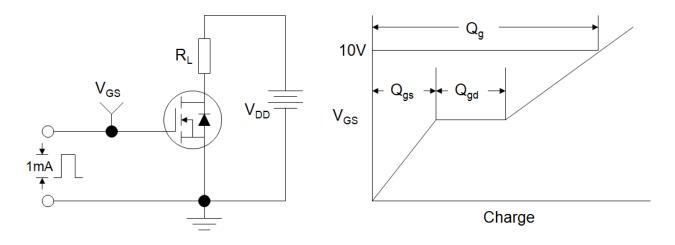


Figure B: Resistive Switching Test Circuit and Waveform

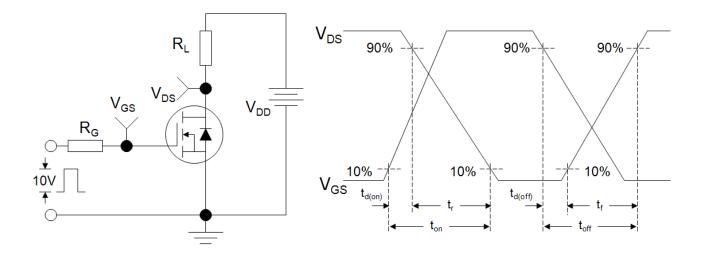
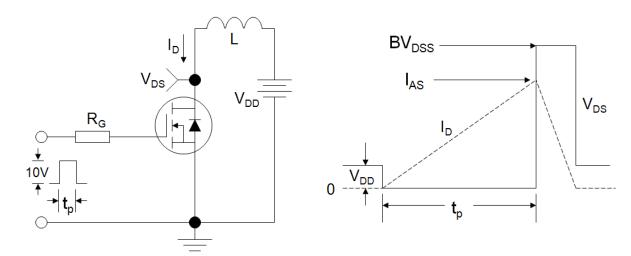


Figure C: Unclamped Inductive Switching Test Circuit and Waveform

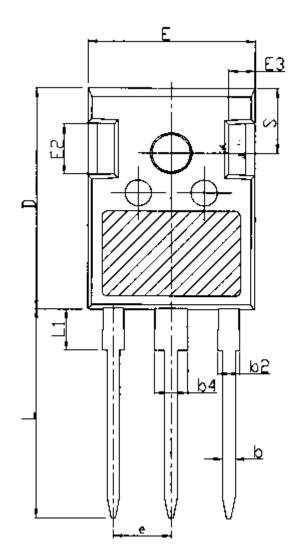


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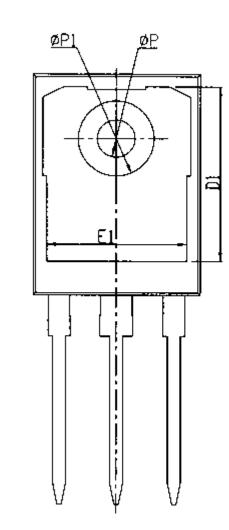
A

<u>A2</u>

<u>A1</u>



t



Unit:mm				
Symbol	Min.	Nom	Max.	
А	4.80	5.00	5.20	
A1	2.21	2.41	2.61	
A2	1.85	2.00	2.15	
b	1.11	1.21	1.36	
b2	1.91	2.01	2.21	
b4	2.91	3.01	3.21	
С	0.51	0.61	0.75	
D	20.70	21.00	21.30	
D1	16.25	16.55	16.85	

Unit:mm					
Symbol	Min. Nom.		Max.		
E	15.50	15.80	16.10		
E1	13.00	13.30	13.60		
E2	4.80	5.00	5.20		
E3	2.30	2.50	2.70		
е	5.44BSC				
L	19.62	19.92	20.22		
L1	-	-	4.30		
ΦP	3.40	3.60	3.80		
ΦP1	-	-	7.30		
S	6.15BSC				

<u>C</u>



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